

BYC75W-600PT2

Hyperfast power diode

Rev.01 - 07 January 2020

Product data sheet

1. General description

Hyperfast power diode in a 2-lead TO247-2L plastic package.

2. Features and benefits

- Fast switching and soft reverse recovery characteristics
- Low forward voltage drop
- · Low leakage current
- · Low reverse recovery current
- Reduces switching losses in associated MOSFET or IGBT

3. Applications

- UPS
- EV Charger
- Welding Machine
- Air Conditioner

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions		Va	lues		Unit
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			600			V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 90 °C; Fig. 1; Fig. 2; Fig. 3	75		A		
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{mb} ≤ 90 °C; square-wave pulse	150		A		
I _{FSM}	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse; <u>Fig. 4</u>	700		A		
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse	750		А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 75 A; T _j = 25 °C; <u>Fig. 6</u>		-	2.2	2.75	V
		I _F = 75 A; T _j = 150 °C; <u>Fig. 6</u>	- 1.6 2.1		2.1	V	
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	-	50	ns

Symbol	Parameter Conditions		Min	Тур	Max	Unit
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	42	-	ns
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	106	-	ns

5. Pinning information

Pin	Pinning infor Symbol	Description	Simplified outline	Graphic symbol
				Graphic Symbol
1	K	cathode		К — 🛃 — А
2	A	anode		001aaa020
mb	mb	mounting base; connected to cathod	К А ТО247-2L	

6. Ordering information

Table 3. Ordering information									
Type number	Package	Orderable part number	Packing	Small packing	Package	Package			
	name		method	quantity	version	issue date			
BYC75W-600PT2	TO247-2L	BYC75W-600PT2Q	Tube	30	TO247L-2L	28-Aug-2018			

7. Marking

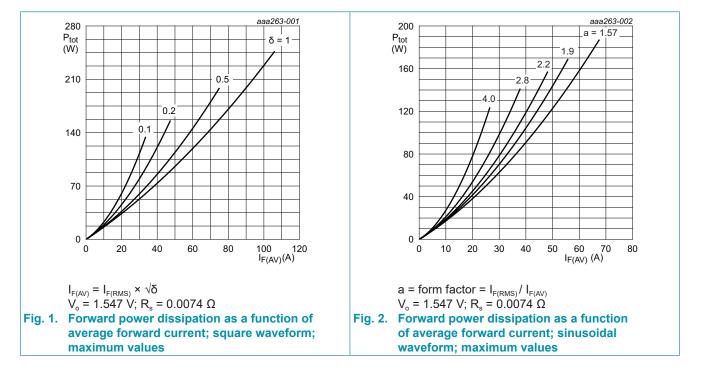
Table 4. Marking codes						
	Type number	Marking codes				
	BYC75W-600PT2	BYC75W-600PT2				

8. Limiting values

Table 5. Limiting values

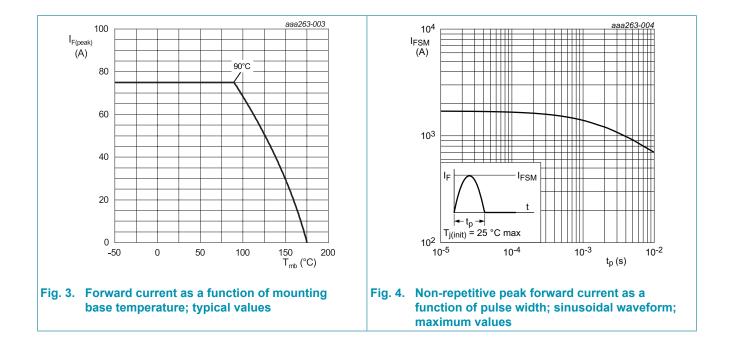
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
$I_{\rm F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 90 °C; Fig. 1; Fig. 2; Fig. 3	75	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 90 °C; square-wave pulse	150	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	700	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	750	А
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



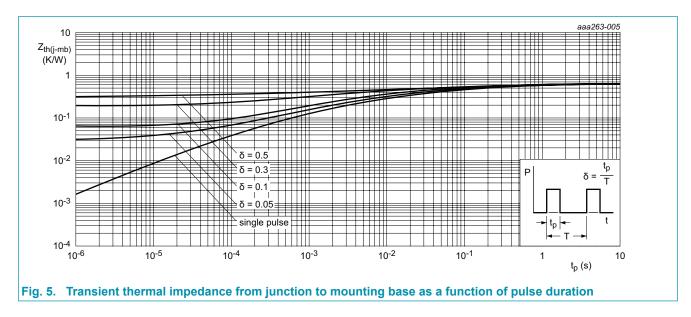
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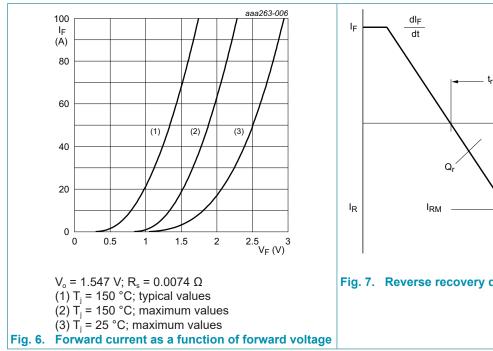
9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.43	0.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
		Conditions		Тур	IVIAX	Unit
Static ch	aracteristics					
V _F	forward current	I _F = 75 A; T _j = 25 °C; <u>Fig. 6</u>	-	2.2	2.75	V
		I _F = 75 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.6	2.1	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	10	μA
		V _R = 600 V; T _j = 125 °C	-	-	1	mA
Dynamic	characteristics					
Q _r	reverse charge	$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	85	-	nC
		I _F = 75 A; V _R = 400 V; dI _F /dt = 200 A/μs; T _j = 125 °C; <u>Fig. 7</u>	-	640	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	50	ns
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	42	-	ns
		$I_F = 75 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{dt} = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	106	-	ns
I _{RM}	peak reverse recovery current	$I_F = 75 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	4.1	-	A
		I _F = 75 A; V _R = 400 V; dI _F /dt = 200 A/μs; T _i = 125 °C; <u>Fig. 7</u>	-	12.2	-	А



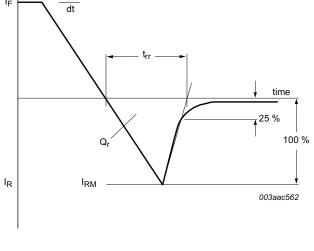
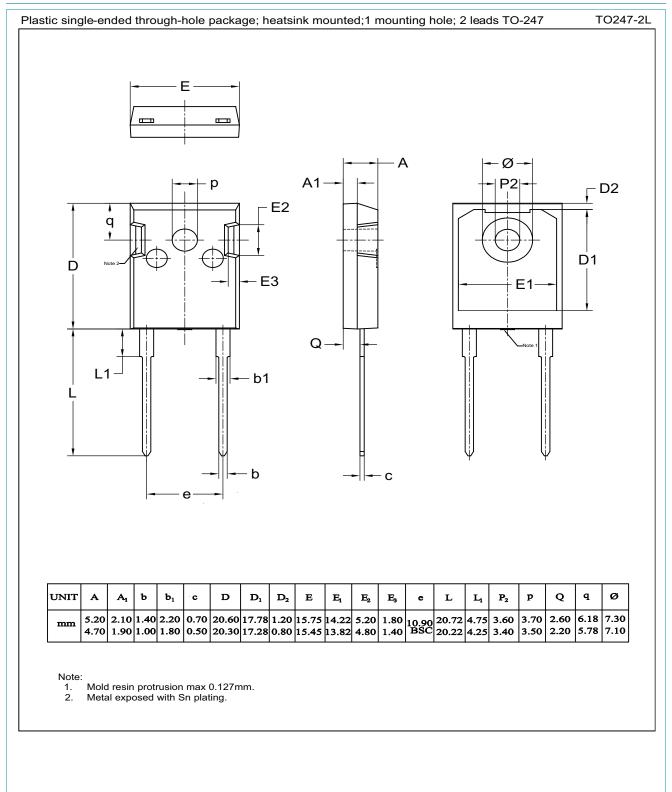


Fig. 7. Reverse recovery definitions; ramp recovery

BYC75W-600PT2 **Product data sheet**

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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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